

LFW



Packet No. EATNP156US

03-IMP-028

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

re **PATENT** application of:

Applicant: Michael Ioannou et al.
Application No.: 10/786,660
For: WAFER 2D SCAN MECHANISM
Filing Date: February 25, 2004
Examiner: Phillip A. Johnston
Art Unit: 2881

REPLY TO OFFICE ACTION DATED JUNE 24, 2005

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Favorable reconsideration of the above-identified application is respectfully requested in view of the following remarks.